

PN2222A NPN General-Purpose Amplifier

Features

• This device is for use as a medium power amplifier and switch requiring collector currents up to 500mA.



Ordering Information

Part Number	Top Mark	Package	Packing Method
PN2222ABU	PN2222A	TO-92 3L	Bulk
PN2222ATA	PN2222A	TO-92 3L	Ammo
PN2222ATF	PN2222A	TO-92 3L	Tape and Reel
PN2222ATFR	PN2222A	TO-92 3L	Tape and Reel

Absolute Maximum Ratings^{(1), (2)}

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^{\circ}$ C unless otherwise noted.

Symbol	Parameter	Value	Unit
V _{CEO}	Collector-Emitter Voltage	40	V
V _{CBO}	Collector-Base Voltage	75	V
V _{EBO}	Emitter-Base Voltage	6.0	V
۱ _C	Collector Current	1.0	Α
T _{STG}	Operating and Storage Junction Temperature Range	-55 to 150	°C

Note:

- 1. These rating are based on a maximum junction temperature of 150 $^\circ\text{C}.$
- 2. These are steady-state limits. Fairchild Semiconductor should be consulted on applications involving pulsed or low-duty-cycle operation.

July 2014

Thermal Characteristics⁽³⁾

Values are at $T_A = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Max.	Unit
Б	Total Device Dissipation	625	mW
PD	Derate Above 25°C	5.0	mW/°C
R _{θJC}	Thermal Resistance, Junction to Case	83.3	°C/W
R _{θJA}	Thermal Resistance, Junction to Ambient	200	°C/W

Note:

3. PCB size: FR-4, 76 mm x 114 mm x 1.57 mm (3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size.

PN2222A — NPN General-Purpose Amplifier

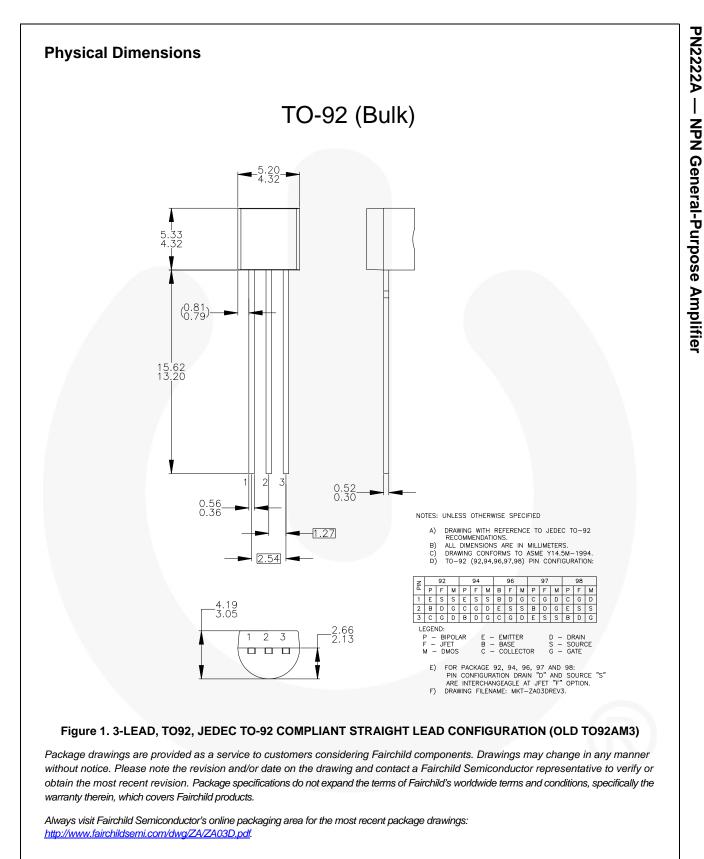
Electrical Characteristics

Values are at $T_A = 25^{\circ}C$ unless otherwise noted.

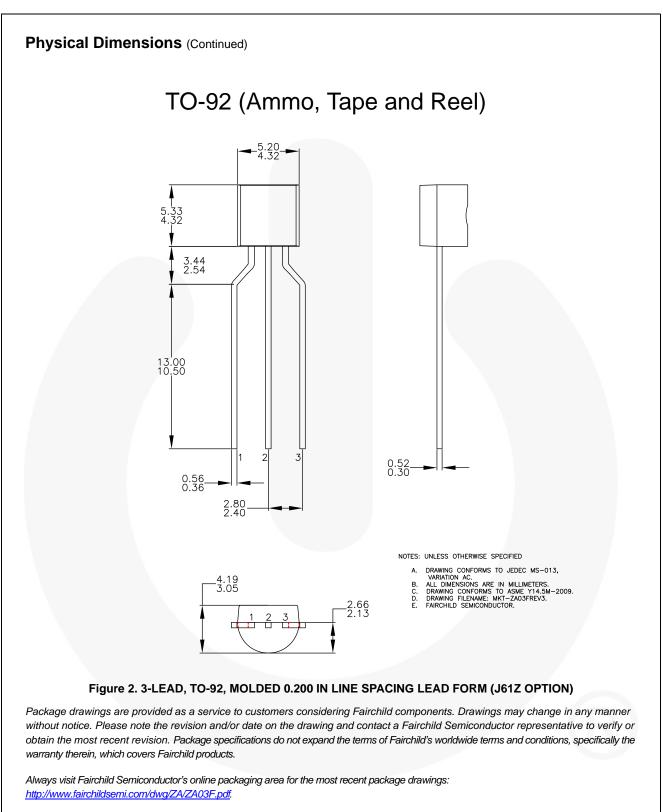
Symbol	Parameter	Conditions	Min.	Max.	Uni
Off Charact	eristics	•			
BV _{(BR)CEO}	Collector-Emitter Breakdown Voltage ⁽⁴⁾	I _C = 10 mA, I _B = 0	40		V
BV _{(BR)CBO}	Collector-Base Breakdown Voltage	I _C = 10 μA, I _E = 0	75		V
BV _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_{E} = 10 \ \mu A, \ I_{C} = 0$	6.0		V
I _{CEX}	Collector Cut-Off Current	$V_{CE} = 60 \text{ V}, V_{EB(off)} = 3.0 \text{ V}$		10	nA
I _{CBO}	Collector Cut-Off Current	$V_{CB} = 60 \text{ V}, I_{E} = 0$		0.01	μΑ
		$V_{CB} = 60 \text{ V}, \text{ I}_{E} = 0, \text{ T}_{A} = 125^{\circ}\text{C}$		10	
I _{EBO}	Emitter Cut-Off Current	$V_{EB} = 3.0 \text{ V}, I_{C} = 0$		10	nA
I _{BL}	Base Cut-Off Current	V_{CE} = 60 V, $V_{EB(off)}$ = 3.0 V		20	nA
On Charact	eristics				
		$I_{C} = 0.1 \text{ mA}, V_{CE} = 10 \text{ V}$	35		
		$I_{C} = 1.0 \text{ mA}, V_{CE} = 10 \text{ V}$	50]
		$I_{C} = 10 \text{ mA}, V_{CE} = 10 \text{ V}$	75		
h _{FE}	DC Current Gain	$I_{C} = 10 \text{ mA}, V_{CE} = 10 \text{ V}, T_{A} = -55^{\circ}\text{C}$	35		
		$I_{\rm C}$ = 150 mA, $V_{\rm CE}$ = 10 V ⁽⁴⁾	100	300	1
		I _C = 150 mA, V _{CE} = 1 V ⁽⁴⁾	50		1
		$I_{\rm C}$ = 500 mA, $V_{\rm CE}$ = 10 V ⁽⁴⁾	40		
M	Collector-Emitter Saturation Voltage ⁽⁴⁾	I _C = 150 mA, I _B = 15 mA		0.3	v
V _{CE(sat)}		$I_{\rm C} = 500 \text{ mA}, I_{\rm B} = 50 \text{ mA}$		1.0	V V
V	Base-Emitter Saturation Voltage ⁽⁴⁾	I _C = 150 mA, I _B = 15 mA	0.6	1.2	V
V _{BE(sat)}	Base Emilier Galaration Voltage	$I_{\rm C} = 500 \text{ mA}, I_{\rm B} = 50 \text{ mA}$		2.0	
Small Signa	al Characteristics				
f _T	Current Gain Bandwidth Product	I _C = 20 mA, V _{CE} = 20 V, f = 100 MHz	300		МН
C _{obo}	Output Capacitance	V _{CB} = 10 V, I _E = 0, f = 1 MHz		8.0	pF
C _{ibo}	Input Capacitance	$V_{EB} = 0.5 V$, $I_{C} = 0$, f = 1 MHz		25	pF
rb'C _c	Collector Base Time Constant	I _C = 20 mA, V _{CB} = 20 V, f = 31.8 MHz		150	pS
NF	Noise Figure	I_{C} = 100 μA, V _{CE} = 10 V, R _S = 1.0 kΩ, f = 1.0 kHz		4.0	dB
Re(h _{ie})	Real Part of Common-Emitter High Frequency Input Impedance	I _C = 20 mA, V _{CE} = 20 V, f = 300 MHz		60	Ω
Switching C	Characteristics				
t _d	Delay Time	V _{CC} = 30 V, V _{EB(off)} = 0.5 V,		10	ns
t _r	Rise Time	$I_{\rm C} = 150 \text{ mA}, I_{\rm B1} = 15 \text{ mA}$		25	ns
t _s	Storage Time	V _{CC} = 30 V, I _C = 150 mA,		225	ns
t _f	Fall Time	$I_{B1} = I_{B2} = 15 \text{ mA}$		60	ns

Note:

4. Pulse test: pulse width $\leq 300~\mu s,$ duty cycle $\leq 2.0\%.$



For current tape and reel specifications, visit Fairchild Semiconductor's online packaging area: <u>http://www.fairchildsemi.com/packing_dwg/PKG-ZA03D_BK.pdf</u>.



For current tape and reel specifications, visit Fairchild Semiconductor's online packaging area: <u>http://www.fairchildsemi.com/packing_dwg/PKG-ZA03F_BK.pdf</u>.



TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

AccuPower™ AX-CAP®, BitSiC™ Build it Now™ CorePLUS™ CorePOWER™ CROSSVOLT™ CTL™ Current Transfer Logic™ DEUXPEED® Dual Cool™ EcoSPARK[®] EfficientMax™ ESBC™ ® F Fairchild®

Fairchild[∞] Fairchild Semiconductor[®] FACT Quiet Series[™] FACT[®] FAST[®] FastvCore[™] FETBench[™] FPS[™] FRFET® Global Power Resource^{s™} GreenBridge™ Green FPS™ Green FPS™ e-Series™ Gmax™ GTO™ IntelliMAX™ **ISOPLANAR™** Making Small Speakers Sound Louder and Better™ MegaBuck™ MICROCOUPLER™ MicroFET™ MicroPak™ MicroPak2™ MillerDrive™ MotionMax™ mWSaver OptoHiT™ **OPTOLOGIC® OPTOPLANAR[®]**

F-PFS™

PowerTrench[®] PowerXS^T Programmable Active Droop™ **OFET** QS™ Quiet Series™ RapidConfigure™ \bigcirc Saving our world, 1mW/W/kW at a time™ SignalWise™ SmartMax™ SMART START™ Solutions for Your Success™ SPM[®] STEALTH™ SuperFET® SuperSOT™-3 SuperSOT™-6 SuperSOT™-8 SupreMOS[®] SyncFET™ Sync-Lock™

TinyBuck[®] TinyCalc[™] TinyLogic[®] TINYOPTO[™] TinyPower[™] TinyPWM[™] TinyWire[™]

TriFault Detect™

TinyBoost[®]

TRUECURRENT[®]* µSerDes™ SerDes[™]

TranSiC™

UHC[®] Ultra FRFET™ UniFET™ VCX™ VisualMax™ VoltagePlus™ XS™ 仙童™

* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

- Life support devices or systems are devices or systems which, (a) are
 intended for surgical implant into the body or (b) support or sustain
 life, and (c) whose failure to perform when properly used in
 accordance with instructions for use provided in the labeling, can be
 reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.
		Rev. 168